	Material Comp © Copyright 2005. I © International and Par	PC, Bannockb	ourn, Illinois. A	ll rights reserved untions.	under both	This docume level parts, t	ent is a declarati he declaration e	on of the ncompass	substances es all lower	within the mar level material	ufacturer lis s for which	ted item. Not he manufact	e: if the item is an urer has engineerin	assembly with low g responsibility.	
752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					Materials ar	ials and Mfg Information				
upplier	Information														
Company name* Co				Company unique ID			Unique ID Authority				Res	Response Date*			
nsemi										202	2024-05-16				
ontact Na	ame	Title - Contact]	Phone - Contact*				Em	Email - Contact*				
roduct-E	Env-Stewards		Product Enviro Compliance				NA				Pro	Product-Env-Stewards@onsemi.com			
uthorized	d Representative*	Title - Representative]	Phone - Representative*				Em	Email - Representative*				
roduct-E	Env-Stewards	Product Enviro Compliance				NA				Pro	Product-Env-Stewards@onsemi.com				
	Requester Item Number Mfr Iten		n Number Mfr Item Name				Effective Date	Version Manufacturing Site		Site	Weight*	UOM	Unit Type		
		LC87F7NP6AVUEJ- 2H 8-bit Microcontrol		oller		2024-05-16 PHM				1500.0	mg	Each			
Ianufac	cturing Proccess Informa	tion													
	Terminal Plating / Grid Array Material		Terminal Base Alloy J-STD		J-STD-020 MS	L Rating	Peak Process Body Tempe		Temperatur	ture Max Time at Peak Te		perature Nu	umber of Reflow C	ycles	
contains Bi		CU Alloy 4		4		260 C		С	30	s	econds 3				
omments															
or more i	information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	amending RoHS RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all							
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	stislav Drska	Le										

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.88	mg	Supplier	Silicon (Si)	7440-21-3		3.8525	mg
			Supplier	Polyimide	Proprietary Data		0.0275	mg
Die Attach	0.38	mg	Supplier	Silver (Ag)	7440-22-4		0.2907	mg
			Supplier	Epoxy resins	129915-35-1		0.0893	mg
Lead Frame	350.5	mg	Supplier	Silver (Ag)	7440-22-4		0.4907	mg
			Supplier	Tin (Sn)	7440-31-5		4.3462	mg
			Supplier	Zinc (Zn)	7440-66-6		1.0164	mg
			Supplier	Silicon (Si)	7440-21-3		2.4184	mg
			В	Nickel (Ni)	7440-02-0		11.181	mg
			Supplier	Copper (Cu)	7440-50-8		331.0472	mg
Mold Compound-Black	1132.7	mg		Epoxy Phenol Resin	proprietary data		135.924	mg
			Supplier	Carbon Black (C)	1333-86-4		4.5308	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		958.2641	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		33.981	mg
Plating	10.65	mg	В	Bismuth (Bi)	7440-69-9		0.0639	mg
			Supplier	Tin (Sn)	7440-31-5		10.5861	mg
Wire Bond - Au	1.89	mg	Supplier	Gold (Au)	7440-57-5		1.89	mg